

ICNT86x2 series Capacitive Touch IC Specifications for Tablet

ICNT8672, ICNT8682, ICNT8692

Model No : ICNT86x2

Document Version : V1.0

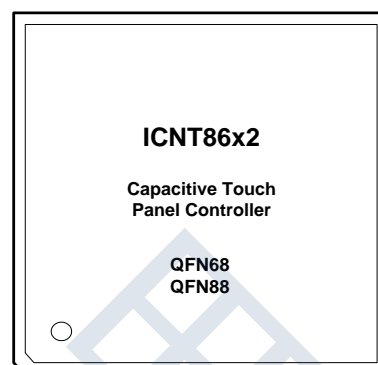
Release Date : 2015/12/14

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Features

- ◇ Combine mutual capacitive and self capacitive sensing techniques
- ◇ Support Glass/Film DITO and SITO, OGS
- ◇ Support Single-Layer Multi-Touch Glass & Film ITO sensor
- ◇ Support I²C interface to communicate with host processor, ICNT8672/ICNT8692 also support SPI interface
- ◇ Built-in MCU and DSP with 48KB of internal flash, 4KB of data SRAM
- ◇ 4 operating modes
 - Active
 - Monitor
 - Hibernate
 - Gesture
- ◇ Support I²C and Gestural wake
- ◇ Operating voltage 2.8 to 3.3V.
- ◇ Support 1.8V/3.3V digital IOVCC.
- ◇ I²C interface (up to 400kbps)
- ◇ 4 wire SPI slave interface (up to 10 MHz) for configuration
- ◇ User-Programmable scan sequences
- ◇ Programmable capacitance resolution
- ◇ Large dynamic range of ADC
- ◇ Insensitive to environmental variations and touch variations
- ◇ Auto calibration.
- ◇ Auto Frequency-Hopping.



1、Description

ICNT86x2 series IC are the low power, general purpose capacitive controller with a built-in 32bit MCU with 48KB flash, the high performance ADC and digital filters. By using the mutual capacitance technique, ICNT86x2 support true multi-touch capability. In conjunction with a mutual capacitive or self-capacitive touch panel, the ICNT86x2 provide user-friendly input functions, which could be applied on many portable devices, especially for the tablets.

The ICNT86x2 series IC include ICNT8672/ICNT8682/ICNT8692; the difference between their specifications will be listed individually in this datasheet.

2、Typical Application

ICNT86x2 accommodates a wide range of applications with a multi-touch sensing device.

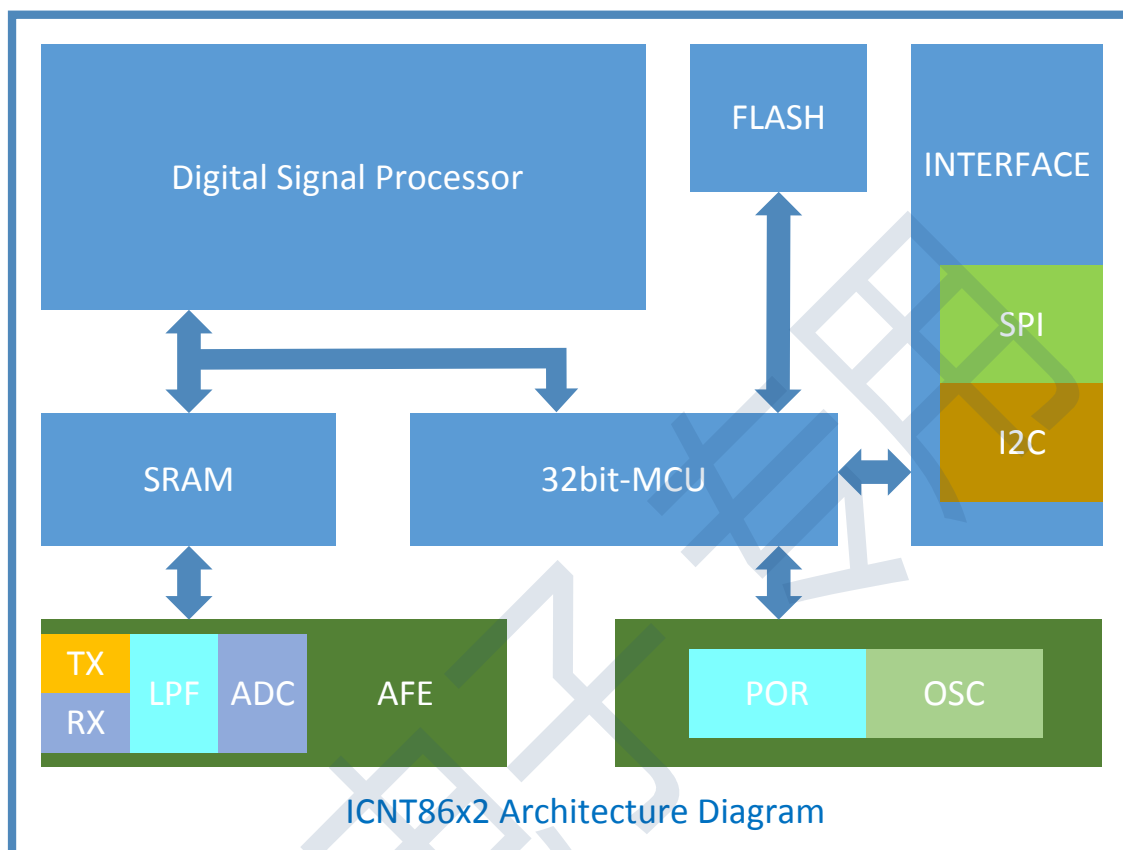
- Tablets
- Portable MP3 and MP4 media players
- Digital cameras
- Game consoles
- Navigation systems
- Information kiosks
- Keyboard, keypad, mouse, remote control
- House appliances
- Home entertainment devices

ICNT86x2 Series IC support 7"~12.1" touch panel, users may find out their target IC from the specs listed as follows.

Model Name	Channels		Package			Touch Panel Size
	TX	RX	Type	Pin	Size	
ICNT8672	28TX*19RX 29TX*18RX 30TX*17RX		QFN	68	8*8	7" ~ 9"
ICNT8682	32TX*24RX 33TX*23RX 34TX*22RX 35TX*21RX 36TX*20RX		QFN	68	8*8	7" ~ 10.1"
ICNT8692	42TX*30RX		QFN	88	10*10	8" ~ 12.1"

3、Functional Description

3.1、Block Diagram



ICNT86x2 can be divided into the following functional blocks:

- Touch Panel Interface
The channel signal is converted by ADC to the digital signal.
- Data Memory
Touch panel data buffer
- MCU
32-bit MCU core with 48KB internal flash, 4KB data SRAM
- Watch Dog Timer
To guarantee the robustness of the chip.
- Voltage Regulator
To generate voltage for internal modules from the input VCC supply.
- Flash
Program codes storage
- External Interface
 - I²C/SPI: interface for system control and data transfer
 - INT/WAKE: interrupt signal to inform the host processor that touch data is ready or wakeup request for the host to change ICNT86x2 from hibernate to active mode
 - /RST: external signal to reset the chip, active low

3.2、Serial Interface(I²C)

There are 2 modes for I²C operation, single byte modes and multi-byte modes. Under single mode, MCU will enter interrupt service routine by every byte transaction, while under multi-byte mode, MCU could enter interrupt service routine only once after internal 8 bytes FIFO is empty or full. The latter will increase the throughput of whole system.

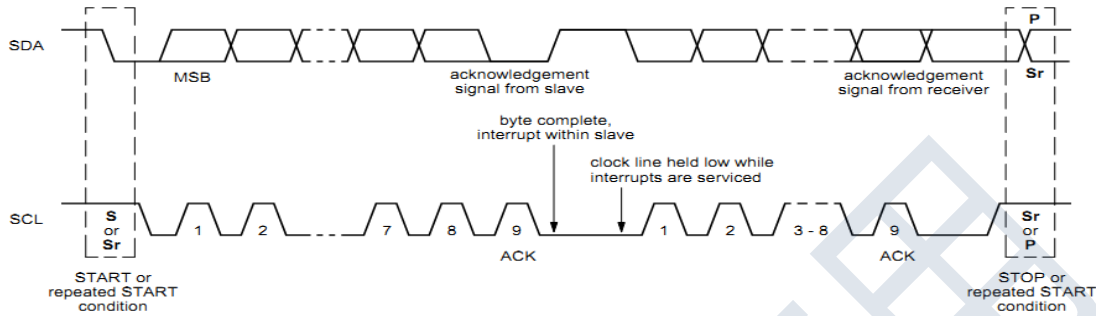


Figure 3-1 I²C Signal Description

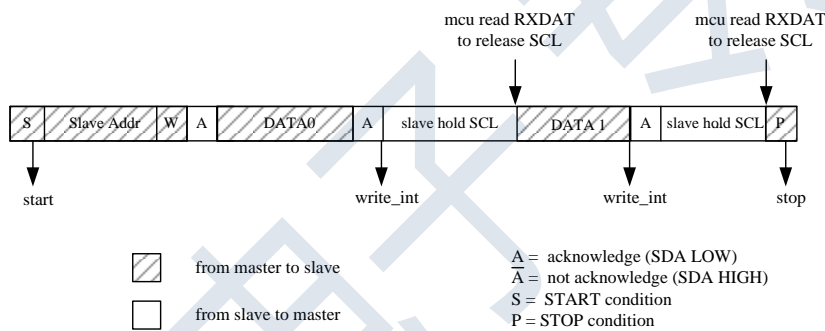


Figure 3-2 I²C single byte write operation

Figure 3-2 above illustrates the single byte write transaction scenario. The I²C start / stop interrupt occurs at the start and stop stage to notify MCU the protocol status. And there will be a write interrupt to notify MCU after I²C master writes each byte to slave. Before MCU reads RXDAT, the SCL will be held automatically.

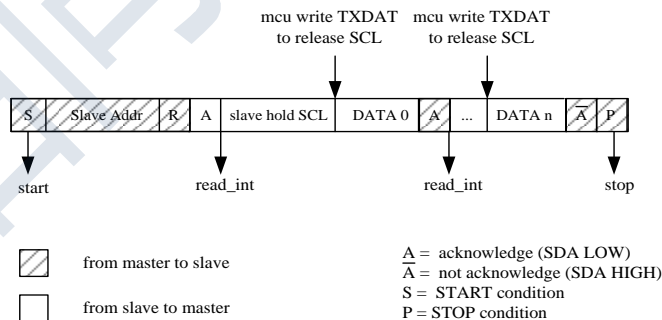


Figure 3-3 I²C single byte read operation

Figure 3-3 above illustrates the single byte read transaction scenario. The I²C start / stop interrupt occurs at the start and stop stage to notify MCU the protocol status. And there will be a read interrupt to notify MCU before I²C master fetches expected data from slave. Before MCU writes TXDAT, the SCL will be held automatically. The last NAK before stop will not trigger read interrupt.

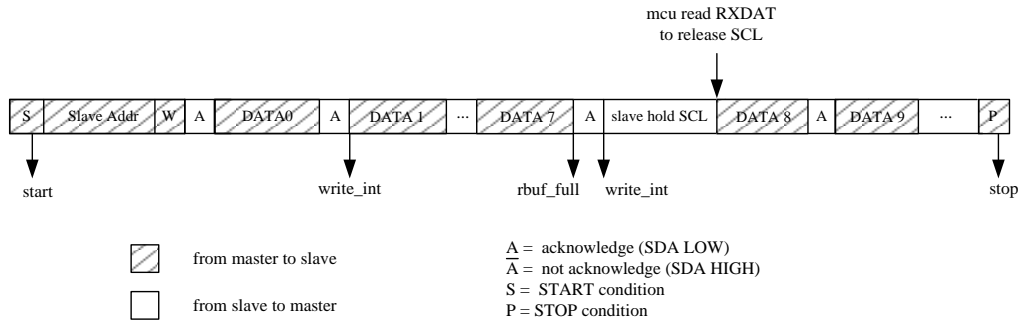


Figure 3-4 I²C multi-byte write operation

Figure 3-4 above illustrates the multi-byte write transaction scenario. There are 8 bytes receive FIFO in I²C slave controller. When I²C slave is configured into multi-byte mode, the SCL will be held by slave only if the receiving FIFO is full and a rbuf_full interrupt will be triggered to notify MCU. After MCU reads RXDAT, the SCL will be released to -receive new data.

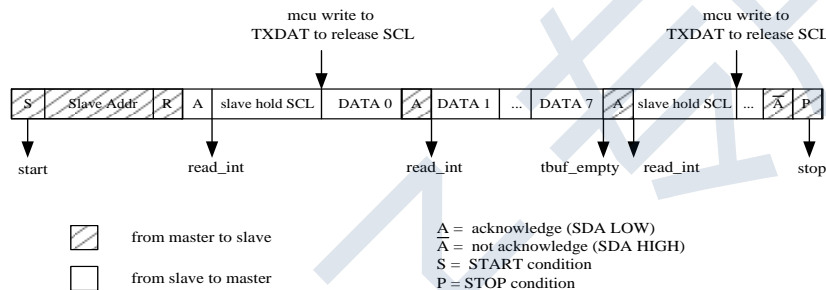


Figure 3-5 I²C multi-byte read operation

Figure 3-5 above illustrates the multi-byte read transaction scenario. There are 8 bytes transmission FIFO in the I²C slave controller. When I²C slave is configured into multi-byte mode, the SCL will be held by the slave only if the transmit FIFO is empty and a tbuf_empty interrupt will be triggered to notify MCU. After MCU writes new data to TXDAT, the SCL will be released for new transaction.

Parameter	Description	Min	Max	Unit
F _{SCL}	SCL clock frequency		400	kHz
T _{LOW}	Low period of SCL clock	1.3		μs
T _{HIGH}	High period of SCL clock	0.6		μs
T _{SU_STA}	Set-up time for a repeated start	0.6		μs
T _{HD_STA}	Hold time (repeated) start condition.	0.6		μs
T _{SU_DAT}	Data set-up time	0.1		μs
T _{HD_DAT}	Data hold time	0.6	0.9	μs
T _R	Rise time of SDA and SCL		300	ns
T _F	Fall time of SDA and SCL		300	ns
T _{SU_STO}	Set-up time for stop condition	0.6		μs
T _{BUF}	Bus free time between a stop and start	1.3		μs

Table 3-1 AC Characteristics of the I²C interface

4、Electrical Specifications

4.1、Absolute Maximum Ratings

Parameter	Description	Min	Typ	Max	Unit	Notes
T _A	Ambient temperature with power applied	-40		80	°C	
T _{STG}	Storage temperature	-45		100	°C	Recommend 25°C ±25°C
VDDA - VSSA	Power Supply Voltage 1	-0.3		3.6	V	
VDD3 – VSS	Power Supply Voltage 2	-0.3		3.6	V	
ESD	Electrostatic discharge voltage of whole chip	2			KV	HBM

Notes

1. If used beyond the absolute maximum ratings, ICNT86x2 may be permanently damaged. It is strongly recommended that the device be used within the electrical characteristics in normal operations. If exposed to the condition not within the electrical characteristics, it may affect the reliability of the device.
2. Make sure VDDA (high) ≥ VSSA (low)
3. Make sure VDD (high) ≥ VSS (low)
4. IOVCC is set to VDD3 or VDD18 by software configuration.

4.2、DC Electrical Characteristics

Parameter	Description	ICNT8672			ICNT8682			ICNT8692			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I _{OPR}	Normal operation mode current		9.7			11.1			15.8		mA
I _{MON}	Monitor mode current		3.5			4.0			5.2		mA
I _{SUS}	Suspend mode current		167			167			167		μA
I _{SLP}	Sleep mode current		91			91			91		μA

Notes

1. The suspend mode current and the sleep mode current measured at room temperature; VCC=3.3V.
2. The suspend mode could be changed to the sleep mode by firmware configuration, and the default mode is suspend mode.

Parameter	Description	Min	Typ	Max	Unit
V _{IL}	Digital input low voltage	-0.3		0.3*IOVCC	V
V _{IH}	Digital input high voltage	0.7*IOVCC		IOVCC	V
V _{OL}	Digital low output voltage			0.3*IOVCC	V
V _{OH}	Digital high output voltage	0.7*IOVCC			V
I _{IL}	Input leakage		1		nA

4.3、AC Electrical Characteristics

AC characteristics of oscillators

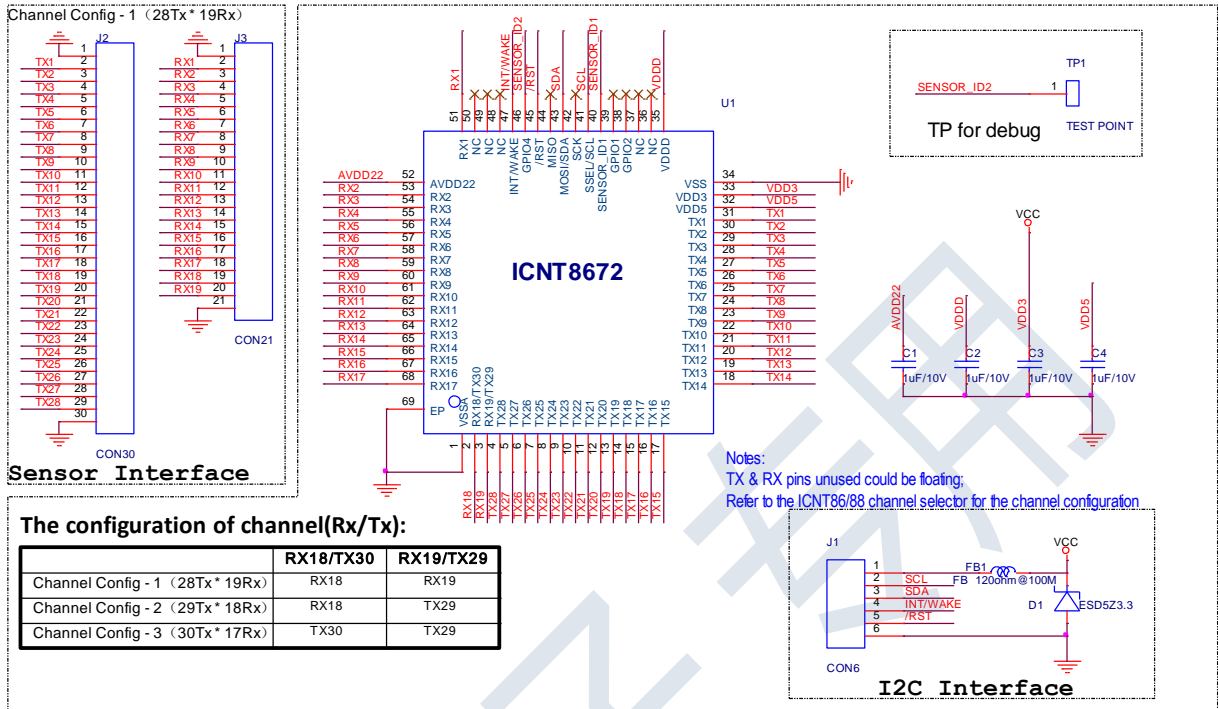
Parameter	Description	Min	Typ	Max	Unit
F _{OSC1}	Frequency of oscillator1		60		MHz

AC characteristics of interface

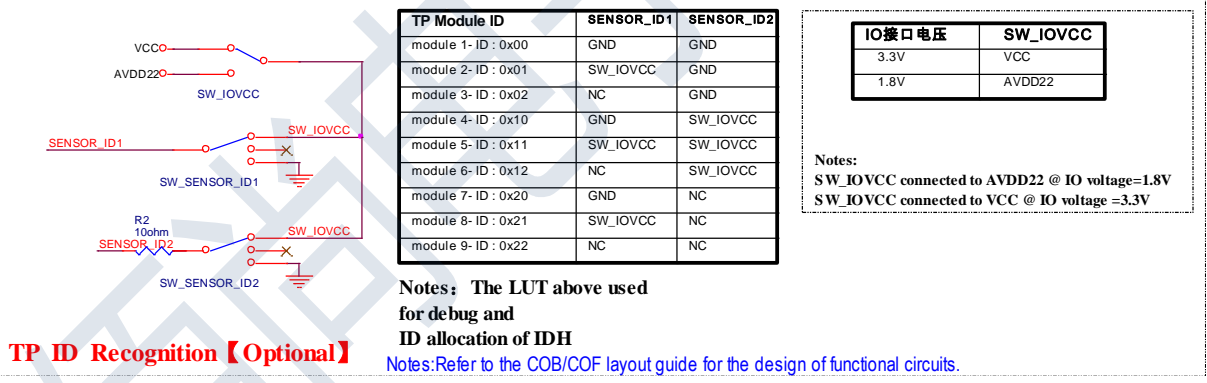
Parameter	Description	Min	Typ	Max	Unit
F _{TX}	TX acceptable clock	30		500	kHz

4.4、Circuit diagram

ICNT8672



Optional circuits as follows (necessary if the function required)



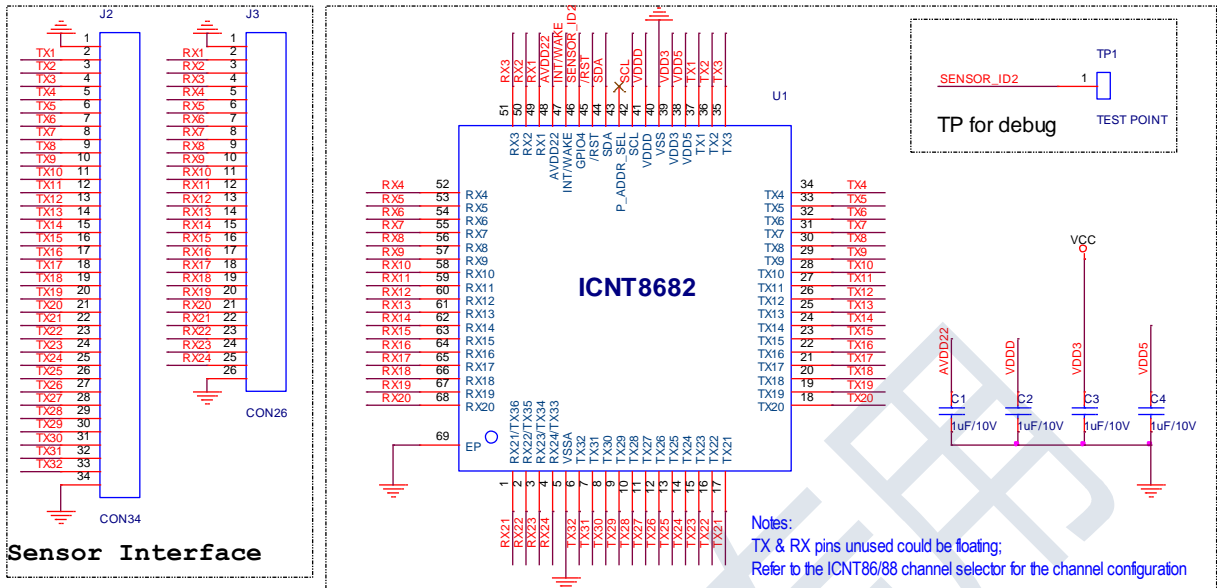
ICNT8672 I²C Interface

Notes

ICNT8672 supports dual frequency driving mode.

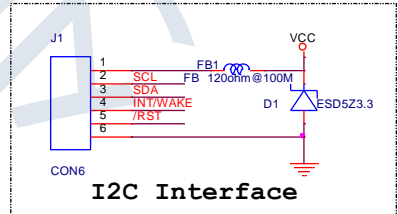
You can find guides from “ICN85xx&ICNT86xx Series COB Layout Design Rule” and “ICN85xx&ICNT86xx Series COF Layout Design Rule”.

ICNT8682



The configuration of channel(Rx/Tx):

	RX21/TX36	RX22/TX35	RX23/TX34	RX24/TX33
Channel Config - 1 (32Tx * 24Rx)	RX21	RX22	RX23	RX24
Channel Config - 2 (33Tx * 23Rx)	RX21	RX22	RX23	TX33
Channel Config - 3 (34Tx * 22Rx)	RX21	RX22	TX34	TX33
Channel Config - 4 (35Tx * 21Rx)	RX21	TX35	TX34	TX33
Channel Config - 5 (36Tx * 20Rx)	TX36	TX35	TX34	TX33



Optional circuits as follows (necessary if the function required)

TP ID Recognition 【Optional】

Notes: The LUT above used for debug and ID allocation of IDH

Notes: Refer to the COB/COF layout guide for the design of functional circuits.

TP Module ID	SENSOR_ID2
Module 1 - ID: 0x02	GND
Module 2 - ID: 0x12	SW_IOVCC
Module 3 - ID: 0x22	NC

IO接口电压	SW_IOVCC
3.3V	VCC
1.8V	AVDD22

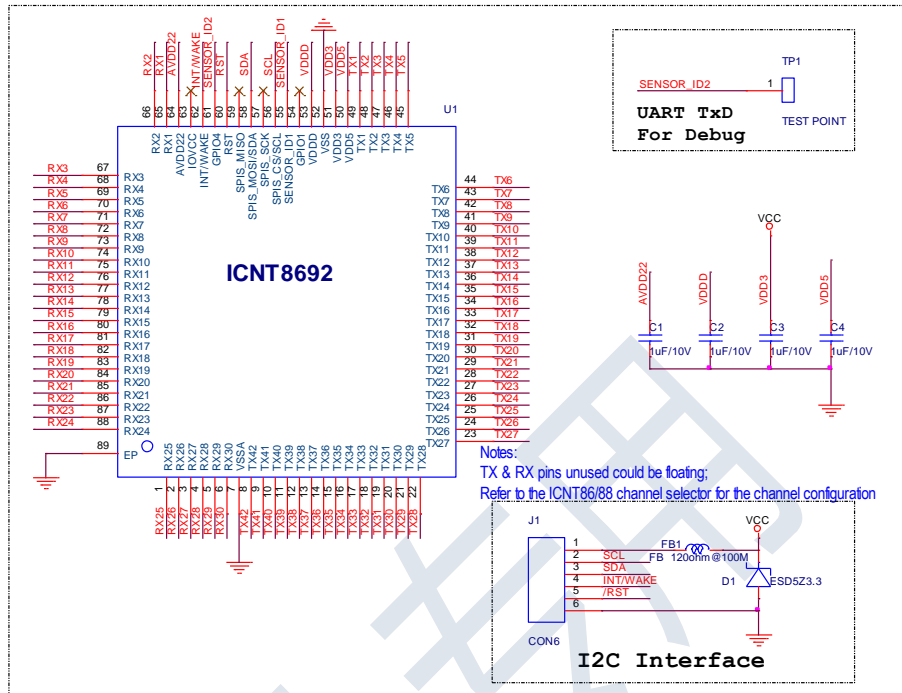
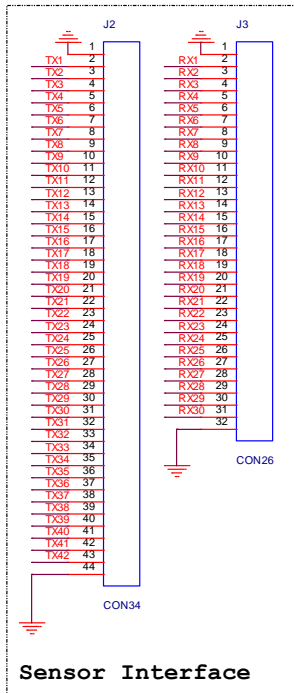
Notes:
SW_IOVCC connected to AVDD22 @ IO voltage=1.8V
SW_IOVCC connected to VCC @ IO voltage =3.3V

ICNT8682 I²C Interface

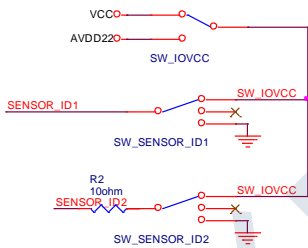
Notes

ICNT8682 supports dual frequency driving mode.
You can find guides from “ICN85xx&ICNT86xx Series COB Layout Design Rule” and “ICN85xx&ICNT86xx Series COF Layout Design Rule”.

ICNT8692



Optional circuits as follows (necessary if the function required)



TP Module ID	SENSOR_ID1	SENSOR_ID2
module 1-ID : 0x00	GND	GND
module 2-ID : 0x01	SW_IOVCC	GND
module 3-ID : 0x02	NC	GND
module 4-ID : 0x10	GND	SW_IOVCC
module 5-ID : 0x11	SW_IOVCC	SW_IOVCC
module 6-ID : 0x12	NC	SW_IOVCC
module 7-ID : 0x20	GND	NC
module 8-ID : 0x21	SW_IOVCC	NC
module 9-ID : 0x22	NC	NC

IO接口电压	SW_IOVCC
3.3V	VCC
1.8V	AVDD22

Notes:
SW_IOVCC connected to AVDD22 @ IO voltage=1.8V
SW_IOVCC connected to VCC @ IO voltage=3.3V

TP ID Recognition 【Optional】

Notes: The LUT above used for debug and ID allocation of IDH

Notes: Refer to the COB/COF layout guide for the design of functional circuits.

ICNT8692 I²C Interface

Notes

ICNT8692 supports dual frequency driving mode.

You can find guides from “ICN85xx&ICNT86xx Series COB Layout Design Rule” and “ICN85xx&ICNT86xx Series COF Layout Design Rule”.

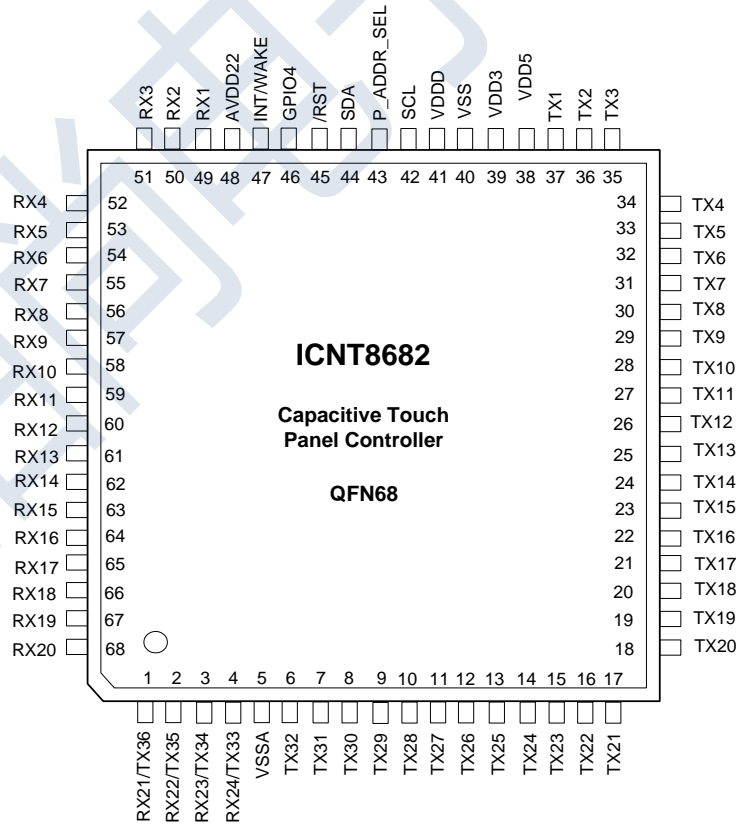
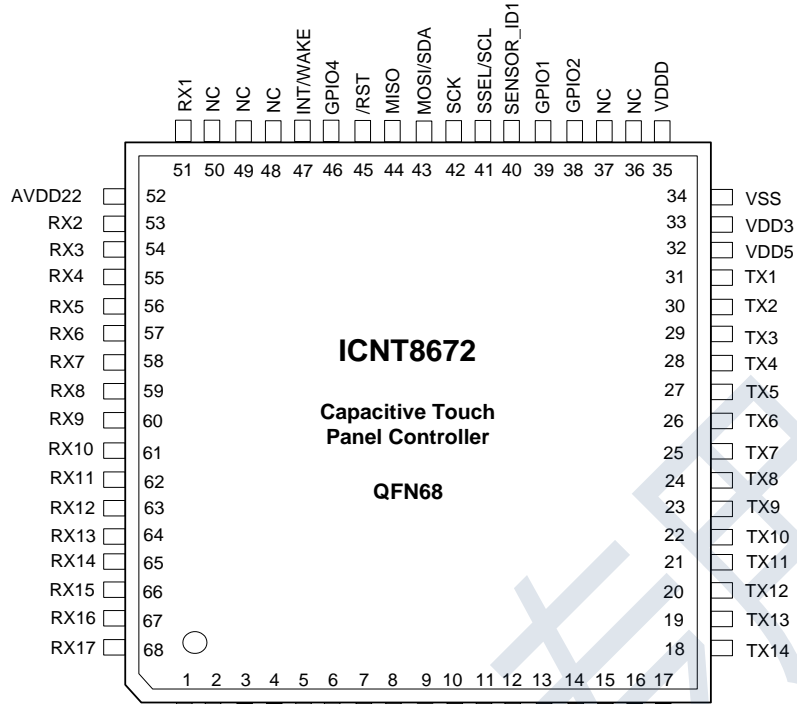
5、PIN DESCRIPTION

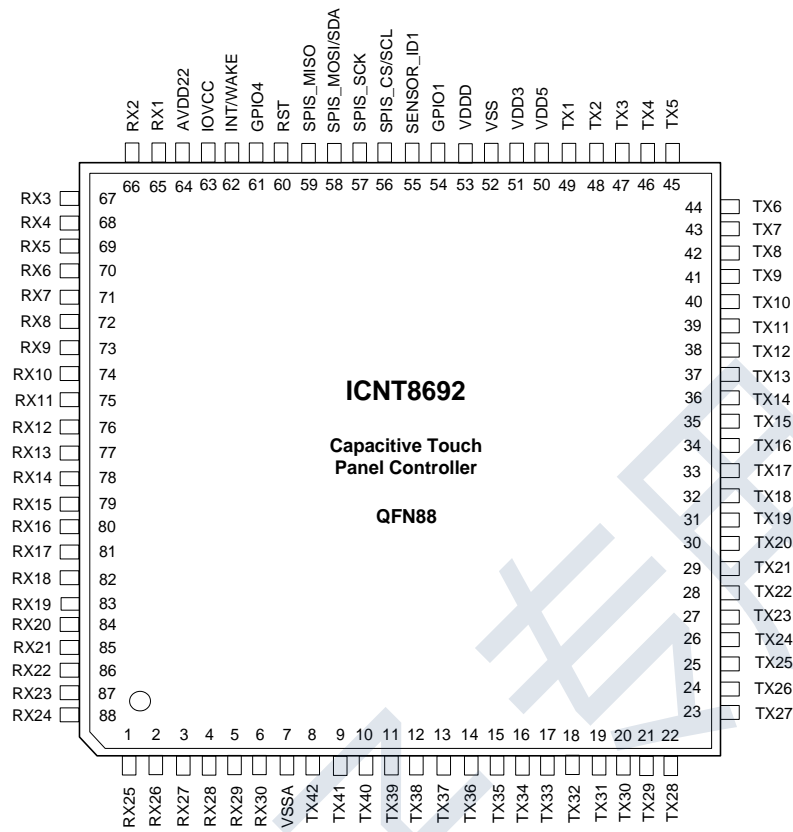
Pin Name	Pin Num			Type	Description
	ICNT8672	ICNT8682	ICNT8692		
RX25			1	I	Receiver input pin
RX26			2	I	Receiver input pin
RX27			3	I	Receiver input pin
RX28			4	I	Receiver input pin
RX29			5	I	Receiver input pin
RX30			6	I	Receiver input pin
VSSA	1	5	7	PWR	Analog ground
TX42			8	O	Transmit output pin
TX41			9	O	Transmit output pin
TX40			10	O	Transmit output pin
TX39			11	O	Transmit output pin
TX38			12	O	Transmit output pin
TX37			13	O	Transmit output pin
TX36			14	O	Transmit output pin
TX35			15	O	Transmit output pin
TX34			16	O	Transmit output pin
TX33			17	O	Transmit output pin
TX32		6	18	O	Transmit output pin
TX31		7	19	O	Transmit output pin
TX30		8	20	O	Transmit output pin
TX29		9	21	O	Transmit output pin
TX28	4	10	22	O	Transmit output pin
TX27	5	11	23	O	Transmit output pin
TX26	6	12	24	O	Transmit output pin
TX25	7	13	25	O	Transmit output pin
TX24	8	14	26	O	Transmit output pin
TX23	9	15	27	O	Transmit output pin
TX22	10	16	28	O	Transmit output pin
TX21	11	17	29	O	Transmit output pin
TX20	12	18	30	O	Transmit output pin
TX19	13	19	31	O	Transmit output pin
TX18	14	20	32	O	Transmit output pin

Pin Name	Pin Num			Type	Description
	ICNT8672	ICNT8682	ICNT8692		
TX17	15	21	33	O	Transmit output pin
TX16	16	22	34	O	Transmit output pin
TX15	17	23	35	O	Transmit output pin
TX14	18	24	36	O	Transmit output pin
TX13	19	25	37	O	Transmit output pin
TX12	20	26	38	O	Transmit output pin
TX11	21	27	39	O	Transmit output pin
TX10	22	28	40	O	Transmit output pin
TX9	23	29	41	O	Transmit output pin
TX8	24	30	42	O	Transmit output pin
TX7	25	31	43	O	Transmit output pin
TX6	26	32	44	O	Transmit output pin
TX5	27	33	45	O	Transmit output pin
TX4	28	34	46	O	Transmit output pin
TX3	29	35	47	O	Transmit output pin
TX2	30	36	48	O	Transmit output pin
TX1	31	37	49	O	Transmit output pin
VDD5	32	38	50	PWR	Internal generated 5V power supply. A 1 μ F ceramic capacitor to ground is required.
VDD3	33	39	51	PWR	Analog power supply
VSS	34	40	52	PWR	Analog ground
VDDD	35	41	53	PWR	Digital power supply (1.2V), generated internal. A 1 μ F ceramic capacitor to ground is required.
GPIO1	39		54	I/O	General Purpose Input/Output port
SENSOR_ID1	40		55	I/O	TP Sensor ID Pin
SSEL/SCL	41		56	I/O	SPI Slave mode: chip select, active low I ² C mode: I ² C clock input
SCK	42		57	I	SPI Slave mode: clock input I ² C mode: I ² C programming address strapping pin, NC/Pull down: I ² C programming address is 0x60/0x61(including R/W bit); Pull up: I ² C programming address is 0xB0/0xB1(including R/W bit);

Pin Name	Pin Num			Type	Description
	ICNT8672	ICNT8682	ICNT8692		
MOSI/SDA	43		58	I/O	SPI Slave mode: data input I ² C mode: I ² C data input and output
SDA		44		I/O	I ² C data input and output
MISO	44		59	O	SPI Slave mode, data output
/RST	45	45	60	I	External Reset, active low
GPIO4	46	46	61	I/O	General Purpose Input/Output port or UART TXD Pin
INT/WAKE	47	47	62	I/O	External interrupt to the host or Wakeup request from the host
IOVCC			63	PWR	IO power supply
AVDD22	52	48	64	PWR	Analog power supply. A 1μF ceramic capacitor to ground is required.
RX1	51	49	65	I	Receiver input pin
RX2	53	50	66	I	Receiver input pin
RX3	54	51	67	I	Receiver input pin
RX4	55	52	68	I	Receiver input pin
RX5	56	53	69	I	Receiver input pin
RX6	57	54	70	I	Receiver input pin
RX7	58	55	71	I	Receiver input pin
RX8	59	56	72	I	Receiver input pin
RX9	60	57	73	I	Receiver input pin
RX10	61	58	74	I	Receiver input pin
RX11	62	59	75	I	Receiver input pin
RX12	63	60	76	I	Receiver input pin
RX13	64	61	77	I	Receiver input pin
RX14	65	62	78	I	Receiver input pin
RX15	66	63	79	I	Receiver input pin
RX16	67	64	80	I	Receiver input pin
RX17	68	65	81	I	Receiver input pin
RX18		66	82	I	Receiver input pin
RX18/TX30	2			I/O	Receiver input pin/ Transmit output pin
RX19		67	83	I	Receiver input pin
RX19/TX29	3			I/O	Receiver input pin/ Transmit output pin

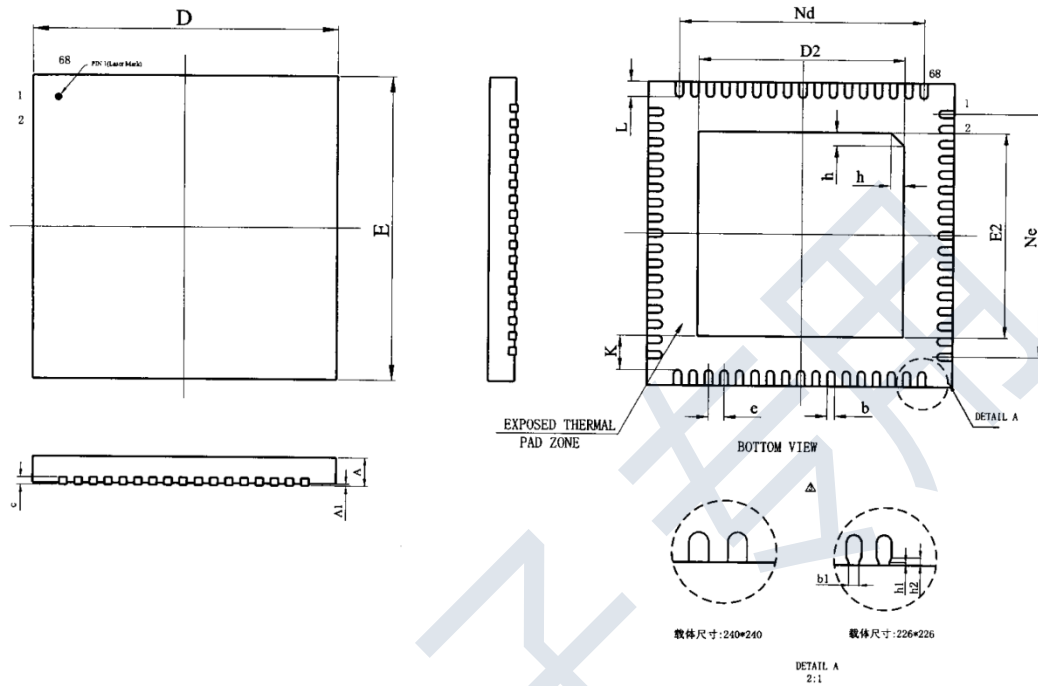
Pin Name	Pin Num			Type	Description
	ICNT8672	ICNT8682	ICNT8692		
RX20		68	84	I	Receiver input pin
RX21			85	I	Receiver input pin
RX21/TX36		1		I/O	Receiver input pin/ Transmit output pin
RX22			86	I	Receiver input pin
RX22/TX35		2		I/O	Receiver input pin/ Transmit output pin
RX23			87	I	Receiver input pin
RX23/TX34		3		I/O	Receiver input pin/ Transmit output pin
RX24			88	I	Receiver input pin
RX24/TX33		4		I/O	Receiver input pin/ Transmit output pin
NC	36				Not connected
NC	37				Not connected
GPIO2	38			I/O	General Purpose Input/Output port
SCL		42		I	I ² C clock input
P_ADDR_SEL		43		I	I ² C programming address strapping pin, NC/Pull down: I ² C programming address is 0x60/0x61(including R/W bit); Pull up: I ² C programming address is 0xB0/0xB1(including R/W bit);
NC	48				Not connected
NC	49				Not connected
NC	50				Not connected





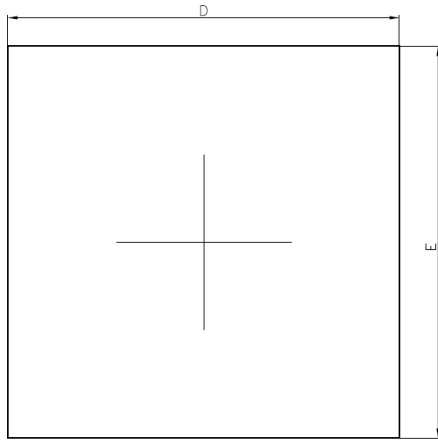
6、Package Outline

QFN-8x8-68L

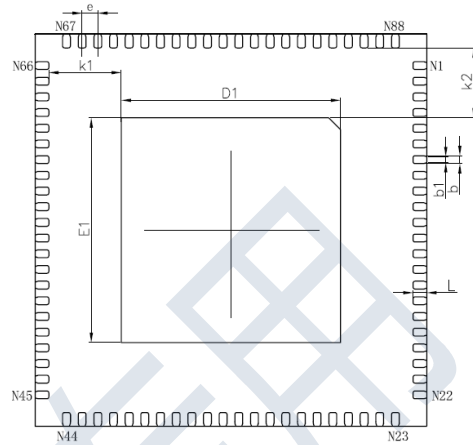


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	—	0.02	0.05
b	0.15	0.20	0.25
b1	0.14REF		
c	0.18	0.20	0.25
D	7.90	8.00	8.10
e	0.40BSC		
Nd	6.40BSC		
E	7.90	8.00	8.10
Ne	6.40BSC		
L	0.35	0.40	0.45
K	0.20	—	—
h	0.30	0.35	0.40
h1	0.04REF		
h2	0.10REF		

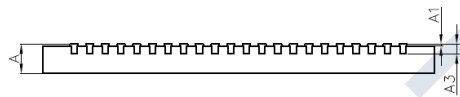
QFN-10x10-88L



TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	9.900	10.100	0.390	0.398
E	9.900	10.100	0.390	0.398
D1	5.500	5.700	0.217	0.224
E1	5.630	5.830	0.222	0.230
b	0.150	0.250	0.006	0.010
b1	0.150REF.		0.006REF.	
e	0.400BSC.		0.016BSC.	
k1	1.850REF.		0.073REF.	
k2	1.785REF.		0.070REF.	
L	0.274	0.426	0.011	0.017

7、 Important Notice

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Revision History

Version	Revisions	Date	Modified by
0.1	1. First draft.	2014-11-04	
0.2	1. Characteristics and features revision 2. Update pin description and circuit diagram 3. SPI description modification.	2014-12-09	
0.3	1.Update the suspend mode and notes	2015-03-16	
0.4	1.Update the circuit diagram	2015-06-05	
1.0	1.Update the POD	2015-12-14	